## FAIRCHILD

SEMICONDUCTOR®

# FDS8984 N-Channel PowerTrench<sup>®</sup> MOSFET

### 30V, 7A, 23m $\Omega$

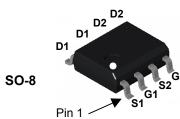
#### **General Description**

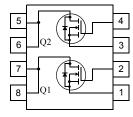
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{\text{DS}(\text{ON})}$  and fast switching speed.

#### Features

- Max  $r_{DS(on)}$  = 23mΩ,  $V_{GS}$  = 10V,  $I_D$  = 7A
- Max  $r_{DS(on)}$  = 30mΩ,  $V_{GS}$  = 4.5V,  $I_D$  = 6A
- Low gate charge
- 100% R<sub>G</sub> tested
- RoHS Compliant







#### **MOSFET Maximum Ratings** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		30	V
V <sub>GS</sub>	Gate to Source Voltage		±20	V
	Drain Current Continuous	(Note 1a)	7	А
D	Pulsed		30	А
E <sub>AS</sub>	Single Pulse Avalache Energy	(Note 2)	32	mJ
D	Power Dissipation for Single Operation		1.6	W
P <sub>D</sub>	Derate above 25°C		13	mW/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to 150	°C
Therma	I Characteristics			
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

## Package Marking and Ordering Information

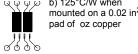
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS8984	FDS8984	SO-8	330mm	12mm	2500 units

FDS8984 N-Channel PowerTrench<sup>®</sup> MOSFET

May 2007

	Parameter	Test Conditions	Min	Тур	Мах	Units	
Off Chara	octeristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	30			V	
ΔBV <sub>DSS</sub> ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$		23		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24V$ $V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			1 250	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA	
)n Chara	cteristics (Note 3)						
	Gate to Source Threshold Voltage	V - V I - 250uA	1.2	1.7	2.5	V	
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$ $I_D = 250\mu A$ , referenced to	1.2	1.7	2.5		
$\frac{\Delta V_{GS(th)}}{\Delta T_{.l}}$	Temperature Coefficient	1 <sub>D</sub> = 250μA, referenced to 25°C		- 4.3		mV/°C	
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 7A		19	23	_	
	Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 6A$		24	30	mΩ	
DS(on)		$V_{GS} = 10V, I_D = 7A,$ T <sub>J</sub> = 125°C		26	32		
Dynamic C <sub>iss</sub> C <sub>oss</sub>	Characteristics Input Capacitance Output Capacitance	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V,		475 100	635 135	pF pF	
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1.0MHz		65	100	pF	
R <sub>G</sub>	Gate Resistance	f = 1MHz		0.9	1.6	Ω	
	g Characteristics (Note 3)			5	10	ns	
t <sub>d(on)</sub>	Turn-On Delay Time			5	10 18	ns	
d(on) r	Turn-On Delay Time Rise Time	$V_{DD} = 15V, I_D = 7A$ $V_{CS} = 10V, R_{CS} = 33\Omega$		9	18	ns	
d(on) r d(off)	Turn-On Delay Time Rise Time Turn-Off Delay Time	V <sub>DD</sub> = 15V, I <sub>D</sub> = 7A V <sub>GS</sub> = 10V, R <sub>GS</sub> = 33Ω		9 42	18 68	ns ns	
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-On Delay Time Rise Time	$V_{GS}^{-}$ = 10V, $R_{GS}^{-}$ = 33Ω $V_{DS}^{-}$ = 15V, $V_{GS}^{-}$ = 10V,		9	18	ns	
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{GS}^{-}$ = 10V, $R_{GS}^{-}$ = 33Ω $V_{DS}^{-}$ = 15V, $V_{GS}^{-}$ = 10V, $I_{D}^{-}$ = 7A		9 42 21	18 68 34	ns ns ns	
td(on) tr td(off) tf Qg Qg	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge	$V_{GS}^{-}$ = 10V, $R_{GS}^{-}$ = 33Ω $V_{DS}^{-}$ = 15V, $V_{GS}^{-}$ = 10V,		9 42 21 9.2	18 68 34 13	ns ns ns nC	
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge	$V_{GS} = 10V, R_{GS} = 33\Omega$ $V_{DS} = 15V, V_{GS} = 10V,$ $I_D = 7A$ $V_{DS} = 15V, V_{GS} = 5V,$		9 42 21 9.2 5.0	18 68 34 13	ns ns nC nC	
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Gate Charge	$V_{GS} = 10V, R_{GS} = 33\Omega$ $V_{DS} = 15V, V_{GS} = 10V,$ $I_D = 7A$ $V_{DS} = 15V, V_{GS} = 5V,$		9 42 21 9.2 5.0 1.5	18 68 34 13	ns ns nC nC nC	
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-So</b>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller" Charge	$V_{GS}^{-} = 10V, R_{GS}^{-} = 33\Omega$ $V_{DS}^{-} = 15V, V_{GS}^{-} = 10V,$ $I_D^{-} = 7A$ $V_{DS}^{-} = 15V, V_{GS}^{-} = 5V,$ $I_D^{-} = 7A$ $I_{SD}^{-} = 7A$		9 42 21 9.2 5.0 1.5 2.0 0.9	18 68 34 13 7 1.25	ns ns nC nC nC nC v	
t <sub>d(on)</sub> t <sub>r</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-So</b> t	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics         Source to Drain Diode Voltage	$V_{GS} = 10V, R_{GS} = 33\Omega$ $V_{DS} = 15V, V_{GS} = 10V,$ $I_{D} = 7A$ $V_{DS} = 15V, V_{GS} = 5V,$ $I_{D} = 7A$ $I_{SD} = 7A$ $I_{SD} = 2.1A$		9 42 21 9.2 5.0 1.5 2.0	18 68 34 13 7 1.25 1.0	ns ns nC nC nC nC v V	
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics	$V_{GS}^{-} = 10V, R_{GS}^{-} = 33\Omega$ $V_{DS}^{-} = 15V, V_{GS}^{-} = 10V,$ $I_D^{-} = 7A$ $V_{DS}^{-} = 15V, V_{GS}^{-} = 5V,$ $I_D^{-} = 7A$ $I_{SD}^{-} = 7A$		9 42 21 9.2 5.0 1.5 2.0 0.9	18 68 34 13 7 1.25	ns ns nC nC nC nC v	

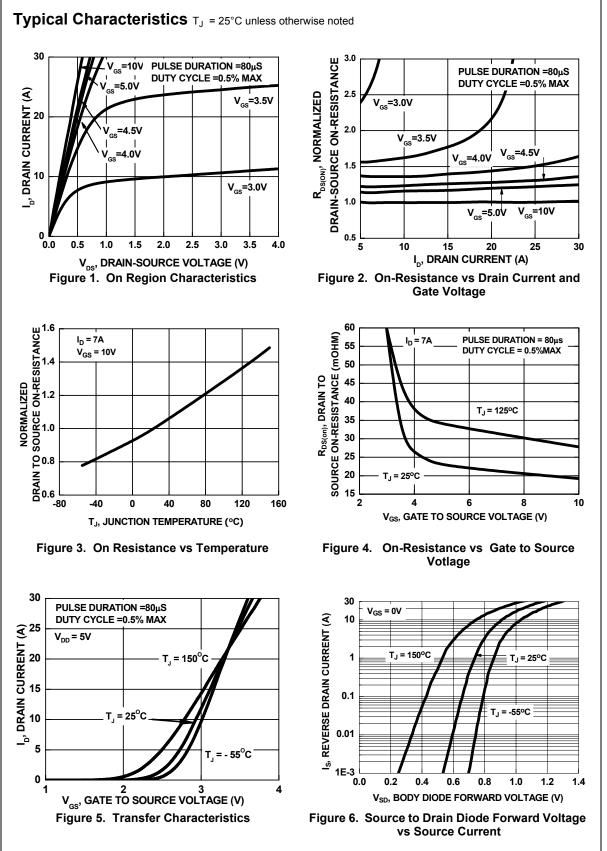




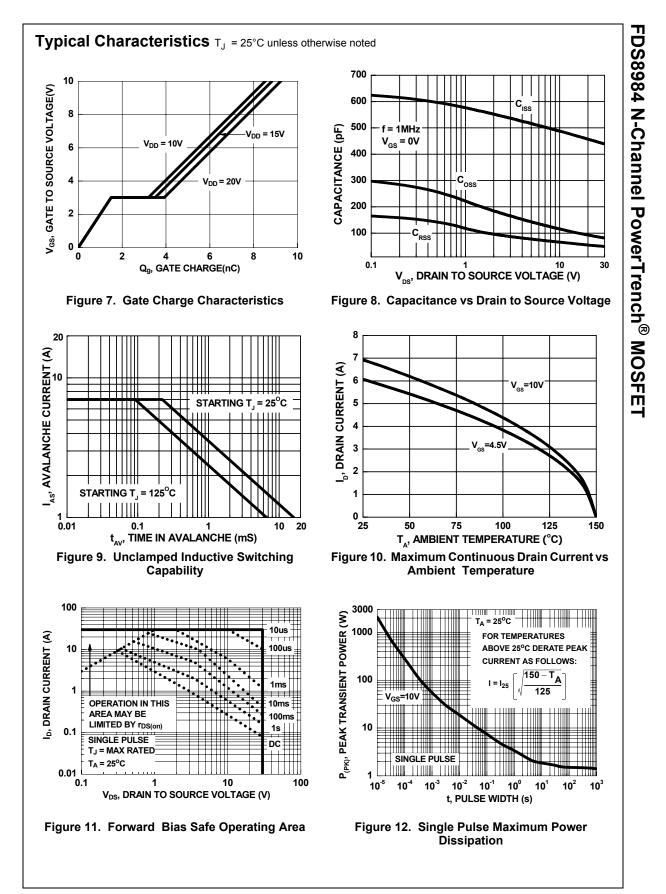
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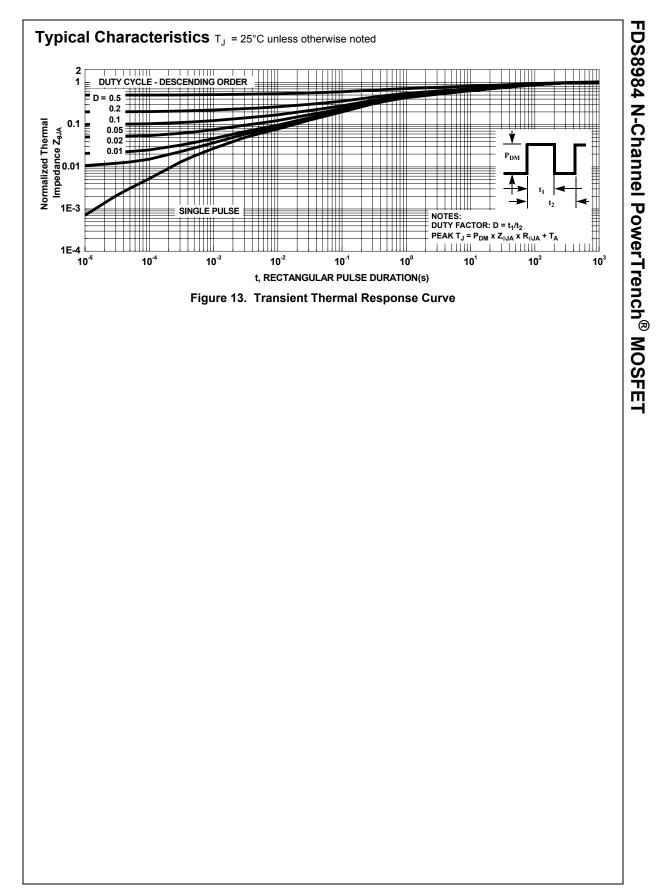
Scale 1 : 1 on letter size paper

2: Starting  $T_J$  = 25°C, L = 1mH,  $I_{AS}$  = 8A,  $V_{DD}$  = 27V,  $V_{GS}$  = 10V. 3: Pulse Test:Pulse Width <300 $\mu$ S, Duty Cycle <2%.









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